

HiPerFRED²

V_{RRM} = 200V
 I_{FAV} = 2x 15A
 t_r = 35ns

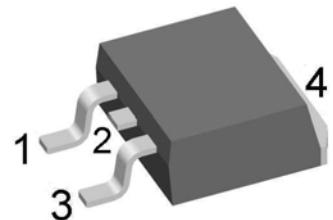
High Performance Fast Recovery Diode

Low Loss and Soft Recovery

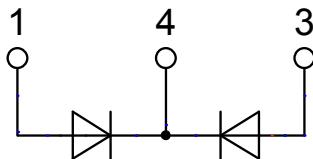
Common Cathode

Part number

DPG30C200PC



Backside: cathode

**Features / Advantages:**

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low I_{rm} -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{rm} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package: TO-263 (D2Pak)

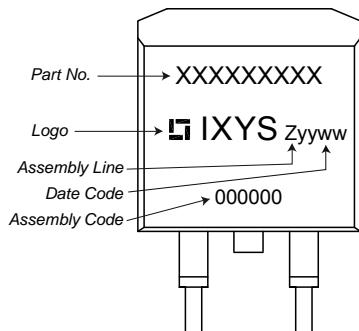
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

Fast Diode

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
V_{RSM}	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			200	V
V_{RRM}	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			200	V
I_R	reverse current, drain current	$V_R = 200 V$ $V_R = 200 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 150^\circ C$		1 0.08	μA mA
V_F	forward voltage drop	$I_F = 15 A$ $I_F = 30 A$ $I_F = 15 A$ $I_F = 30 A$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 150^\circ C$		1.26 1.51 1.01 1.29	V V V V
I_{FAV}	average forward current	$T_C = 145^\circ C$ rectangular $d = 0.5$	$T_{VJ} = 175^\circ C$		15	A
V_{F0} r_F	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 175^\circ C$		0.69 18	V $m\Omega$
R_{thJC}	thermal resistance junction to case				1.7	K/W
R_{thCH}	thermal resistance case to heatsink			0.25		K/W
P_{tot}	total power dissipation		$T_C = 25^\circ C$		90	W
I_{FSM}	max. forward surge current	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}; V_R = 0 V$	$T_{VJ} = 45^\circ C$		240	A
C_J	junction capacitance	$V_R = 150 V$ $f = 1 \text{ MHz}$	$T_{VJ} = 25^\circ C$	20		pF
I_{RM}	max. reverse recovery current		$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	3 6.5		A A
t_{rr}	reverse recovery time	$I_F = 15 A; V_R = 130 V$ $-di_F/dt = 130 A/\mu s$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	35 55		ns ns

Package TO-263 (D2Pak)			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			35	A
T_{VJ}	virtual junction temperature		-55		175	°C
T_{op}	operation temperature		-55		150	°C
T_{stg}	storage temperature		-55		150	°C
Weight				2		g
F_c	mounting force with clip		20		60	N

Product Marking



Part number

D = Diode
 P = HiPerFRED
 G = extreme fast
 30 = Current Rating [A]
 C = Common Cathode
 200 = Reverse Voltage [V]
 PC = TO-263AB (D2Pak) (2)

Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DPG30C200PC	DPG30C200PC	Tape & Reel	800	506675

Similar Part	Package	Voltage class
DPG30C200PB	TO-220AB (3)	200
DPG30C200HB	TO-247AD (3)	200

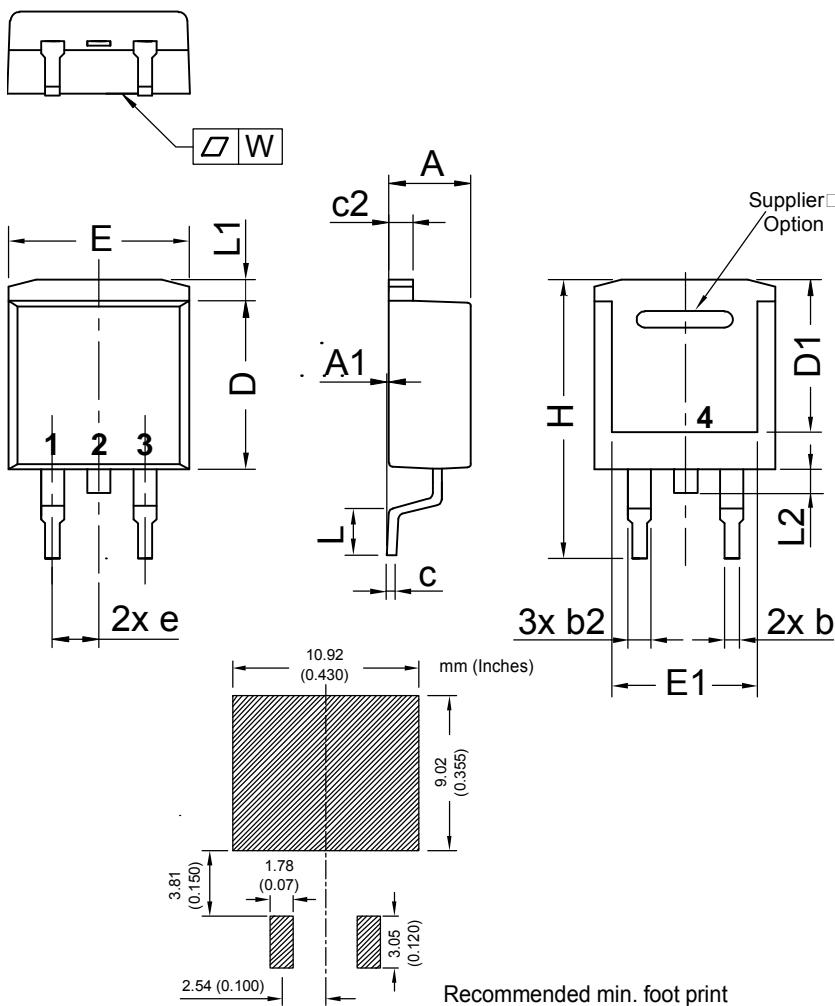
Equivalent Circuits for Simulation

* on die level

 $T_{VJ} = 175 \text{ }^{\circ}\text{C}$

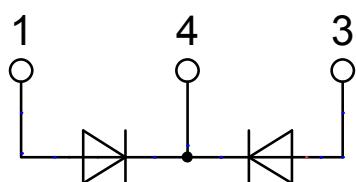
	Fast Diode	
$V_{0\max}$	threshold voltage	0.69
$R_{0\max}$	slope resistance *	14.7

Outlines TO-263 (D2Pak)



Dim.	Millimeter		Inches	
	min	max	min	max
A	4.06	4.83	0.160	0.190
A1	typ. 0.10		typ. 0.004	
A2	2.41		0.095	
b	0.51	0.99	0.020	0.039
b2	1.14	1.40	0.045	0.055
c	0.40	0.74	0.016	0.029
c2	1.14	1.40	0.045	0.055
D	8.38	9.40	0.330	0.370
D1	8.00	8.89	0.315	0.350
D2	2.5		0.098	
E	9.65	10.41	0.380	0.410
E1	6.22	8.50	0.245	0.335
e	2,54 BSC		0,100 BSC	
e1	4.28		0.169	
H	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	1.02	1.68	0.040	0.066
W	typ. 0.02	0.040	typ. 0.0008	0.002

All dimensions conform with
and/or within JEDEC standard.



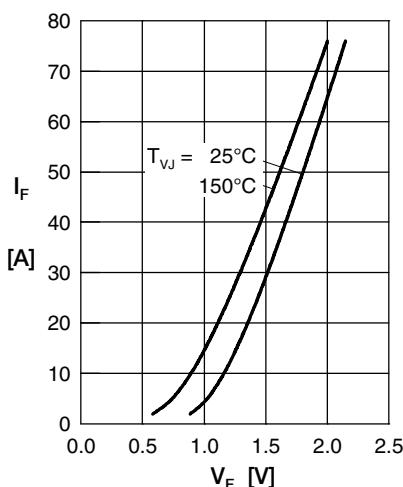
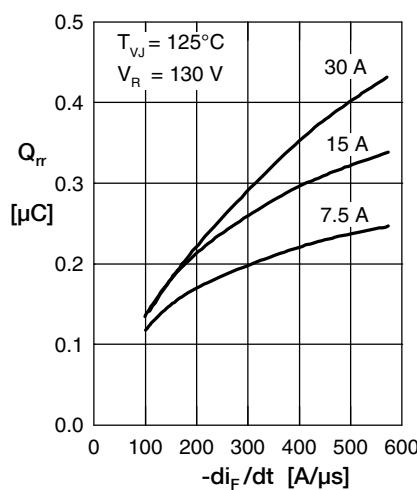
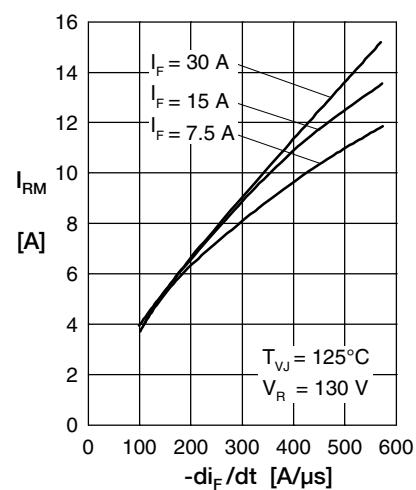
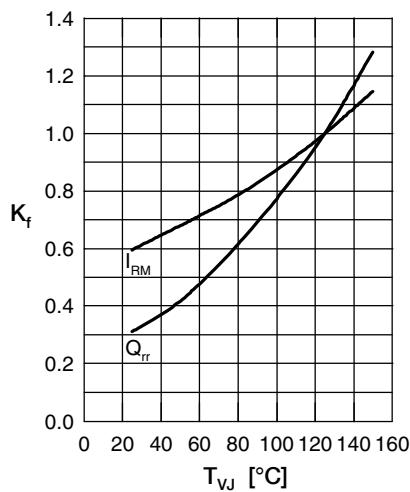
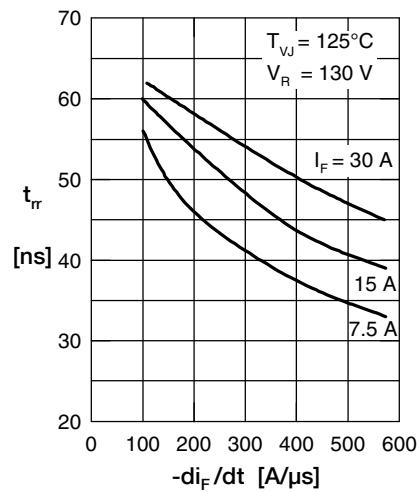
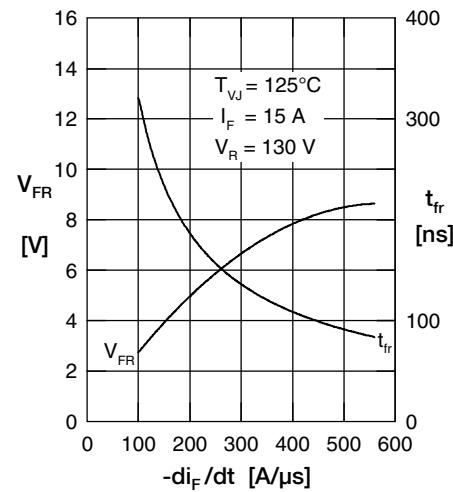
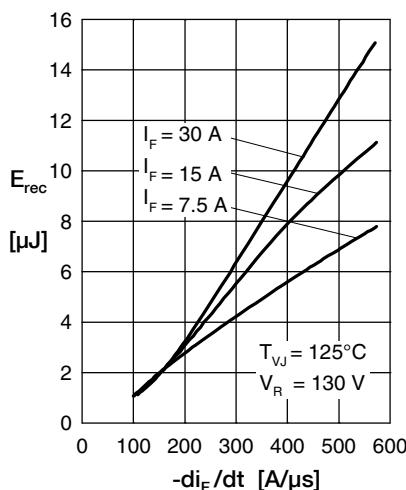
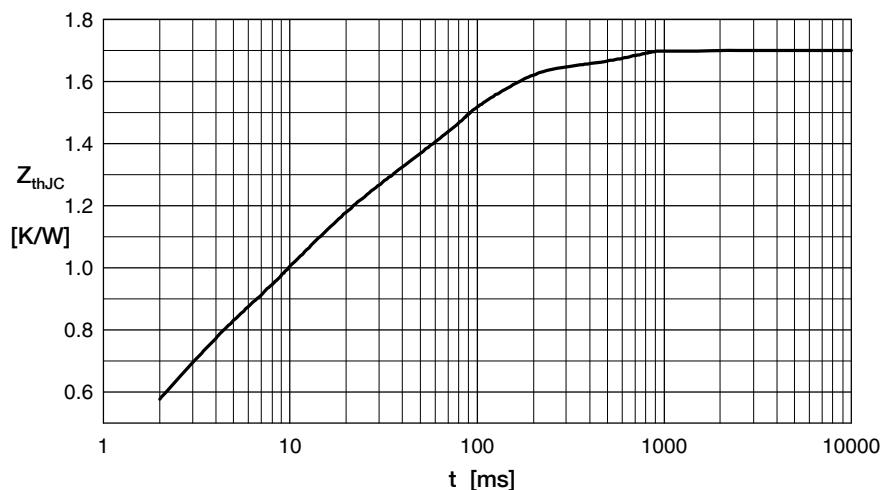
Fast DiodeFig. 1 Forward current I_F versus V_F Fig. 2 Typ. reverse recov. charge Q_{rr} versus $-di_F/dt$ Fig. 3 Typ. peak reverse current I_{RM} versus $-di_F/dt$ Fig. 4 Typ. dynamic parameters Q_{rr} , I_{RM} versus T_{VJ} Fig. 5 Typ. recovery time t_{rr} versus $-di_F/dt$ Fig. 6 Typ. peak forward voltage V_{FR} and t_{fr} versus di_F/dt Fig. 7 Typ. recovery energy E_{rec} versus $-di_F/dt$ 

Fig. 8 Transient thermal resistance junction to case